| Electronic Acknowledgement Receipt | | | |
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| EFS ID: | 1063589 | | |
| Application Number: | 10596139 | | |
| Confirmation Number: | 2702 | | |
| Title of Invention: | RESIN COMPOSITION, MOLDED PRODUCT OBTAINED FROM RESIN COMPOSITION AND METHOD FOR PREPARATION OF RESIN COMPOSITION | | |
| First Named Inventor: | Shinichiro Yamada | | |
| Customer Number: | 26263 | | |
| Filer: | David Richard Metzger/Barbara Hannon | | |
| Filer Authorized By: | David Richard Metzger | | |
| Attorney Docket Number: | 09792909-6492 | | |
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| Application Type: | U.S. National Stage under 35 USC 371 | | |
| International Application Number: | PCT/JP04/17729 | | |
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| Payment was successfully received in RAM | \$2150 | | |

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| 1 | | Sony_6492_Spec.pdf | 234122 | yes | 68 |
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| | | Multipart Description | n | | |
| | Doc De | sc | Start | Er | nd |
| | Specifica | tion | 1 | 6 | 3 |
| | Claims | 3 | 64 | 6 | 7 |
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| Warnings: | | | | | |
| Information | : | | | | |
| 2 | Documents submitted with 371 Applications | Sony_6492_PCT_Req.pdf | 167287 | no | 7 |
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| Information | : | | | | |
| 3 | Foreign Reference | Sony_6492_IDS_Ref1.pdf | 902700 | no | 16 |
| Warnings: | | | | | |
| Information | : | | | | |
| 4 | Foreign Reference | Sony_6492_IDS_Ref2.pdf | 296786 | no | 8 |
| Warnings: | | | | | |
| Information | : | | | | |
| 5 | Foreign Reference | Sony_6492_IDS_Ref3.pdf | 1459332 | no | 25 |
| Warnings: | | | | | |
| Information | : | | | | |
| 6 | NPL Documents | Sony_6492_ISR_NPL.pdf | 60477 | no | 1 |
| Warnings: | | | | | |
| Information | : | | | | |
| 7 | Information Disclosure Statement (IDS) Filed | Sony_6492_US_IDS_Form_ _SB_08a.pdf | 924395 | no | 4 |
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National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/IDO/ED/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filling Receipt, in due course.